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APPLICATION NO.		FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/705,405		11/10/2003	William M. Hiatt	2269-5558B US (99-0253.01	4408
24247	7590	09/27/2006		EXAMINER	
TRASK BRITT P.O. BOX 2550				HECKERT, JASON MARK	
	SALT LAKE CITY, UT 84110			ART UNIT	PAPER NUMBER
				1746	
				DATE MAILED: 09/27/2000	6

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)	
	10/705,405	HIATT ET AL.	
Office Action Summary	Examiner	Art Unit	
	Jason Heckert	1746	
The MAILING DATE of this communication Period for Reply	appears on the cover sheet w	ith the correspondence addre	ss
A SHORTENED STATUTORY PERIOD FOR RIWHICHEVER IS LONGER, FROM THE MAILIN - Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communicatio. - If NO period for reply is specified above, the maximum statutory provided to reply within the set or extended period for reply will, by some years and patent term adjustment. See 37 CFR 1.704(b).	G DATE OF THIS COMMUNI FR 1.136(a). In no event, however, may a n. eriod will apply and will expire SIX (6) MOI statute, cause the application to become Al	CATION. reply be timely filed NTHS from the mailing date of this comminion of the comministry of the commin	
Status			
1) Responsive to communication(s) filed on _ 2a) This action is FINAL. 2b) 3) Since this application is in condition for all closed in accordance with the practice uncondition.	This action is non-final. owance except for formal mat		erits is
Disposition of Claims			
4) Claim(s) <u>1-57</u> is/are pending in the applica 4a) Of the above claim(s) is/are with 5) Claim(s) is/are allowed. 6) Claim(s) <u>1-57</u> is/are rejected. 7) Claim(s) is/are objected to. 8) Claim(s) are subject to restriction a	ndrawn from consideration.	·	·
Application Papers			
9) The specification is objected to by the Example 10) The drawing(s) filed on is/are: a) Applicant may not request that any objection to Replacement drawing sheet(s) including the continuous The oath or declaration is objected to by the	accepted or b) objected to the drawing(s) be held in abeya correction is required if the drawing	nce. See 37 CFR 1.85(a). g(s) is objected to. See 37 CFR	
Priority under 35 U.S.C. § 119			
12) Acknowledgment is made of a claim for for a) All b) Some * c) None of: 1. Certified copies of the priority docur 2. Certified copies of the priority docur 3. Copies of the certified copies of the application from the International But * See the attached detailed Office action for a	ments have been received. ments have been received in A priority documents have beer ureau (PCT Rule 17.2(a)).	Application No n received in this National Sta	age
Attachment(s) 1) ☑ Notice of References Cited (PTO-892) 2) ☐ Notice of Draftsperson's Patent Drawing Review (PTO-948) 3) ☑ Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date 3/7/2005, 12/3/04	8) Paper No	Summary (PTO-413) (s)/Mail Date Informal Patent Application 	

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DETAILED ACTION

Claim Rejections - 35 USC § 112

- The following is a quotation of the second paragraph of 35 U.S.C. 112:
 The specification shall conclude with one or more claims particularly pointing out and distinctly claiming the subject matter which the applicant regards as his invention.
- 2. In claim 45 and 46, the phrase "high pressure" contains relative and vague terminology. In general, nozzles discharge a fluid at a pressure higher than atmospheric.

Claim Rejections - 35 USC § 102

3. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 4. Claims 1 8, 11-16, 35-40, 43-44, 49-51, 54, 57 are rejected under 35
 U.S.C. 102(b) as being anticipated by Sumnitsch. Sumnitsch discloses a substrate processing apparatus consisting of a fabrication or etching site with a material removal component (Fig. 3). The material removal component comprises a support 1 located within the fabrication site that can be raised or lowered. Said support is capable of rotating to facilitate the removal of waste from the surface of the substrate. Sumnitsch clearly shows in Figure 3 that the apparatus is designed so that receptacles 25, 26, and 27 by means of orifices 28, 29, and 30 capture the waste so that it does not fall back into the fabrication site. Said receptacles are in communication with reservoirs 46 and 47 via conduits 39-41 whereby waste material and cleaning or etching agents are

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returned to said reservoirs. Madsen discloses that pumps can be included to facilitate the movement of fluids (col. 5 lines 36-37).

- 5. Sumnitsch also teaches that cleaning agents and rinsing water can be applied to the surface of a substrate via joint aperture 42. As stated previously, Sumnitsch discloses multiple receptacles stacked on top of one another. The fabrication site and support are showed as being enclosed in tank 20 in Figure 3, and the applicator 42 is external to the tank. This tank serves as a protective cover in between the support and unconsolidated material. The receptacles are located on the periphery of the substrate support, and the material removal components, such as the conduits and reservoirs, are located outside of the tank.
- 6. As stated previously, the support element 1 is capable of rotating both during and after application of a cleaning agent. This rotation constitutes agitation. The different receptacles 25-27 that surround the periphery are in line with different cleaning zones, wherein when the support is in line with a receptacle, aperture 42 applies a certain agent from reservoirs 46, 46, or water line 43. Said aperture can be adjusted to obtain the desired distance from the support structure (col. 5 line 15-16).
- 7. In regards to claims 49-54, 57 the device disclosed by Sumnitsch, as stated previously, is capable of discharging a material to the surface of a substrate, removing the excess waste, and returning it to a reservoir. This is structurally equivalent to the device of claim 49. While features of an apparatus may be recited either structurally or functionally, claims directed to an apparatus must be distinguished from the prior art in terms of structure rather than function. *In re Schreiber*, 128 F.3d 1473, 1477-78, 44

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USPQ2d 1429. 1431-32 (Fed. Cir. 1997). As stated previously, Sumnitsch discloses conduit lines for transporting the material to the reservoirs as well as the possible inclusion of pumps to facilitate fluid transfer.

- 8. Claim 1, 16-36, 40, 45-47 are rejected under 35 U.S.C. 102(e) as being anticipated by Madsen. Madsen discloses a fabrication and cleaning chamber 12 and a material removal component downstream of the fabrication chamber contain a plurality of material removal heads 14 that are oriented toward the surface of the substrates processed. Madsen further discloses that some of the heads 14 are capable of sucking the material to be removed. Such suction, by definition, implies the use of a negative pressure source suitable for the removal of a substantial amount of waste. A material reclamation system comprised of tub 15, pump 16, and water tank 17 is in communication with the heads 14 (col. 2 line 58-60). The material is then returned from the heads to the water tank by means of the pump via the tub. This tub serves the same function as a reservoir, and connectively these structures provide the function of a conduit. Madsen discloses that the removed material can pass through a filter (col. 3 line 19), which separates the waste material from the originally supplied material.
- 9. As state previously, Madsen discloses a plurality of material removal heads 14. Some of these heads discharge a sharp jet of pressurized air (col. 2 line 43) and are referred to as air-knives (col. 2 line 41). These heads are used to remove waste from the surface of the substrates processed. Said heads have positioning elements so that they may be located at a suitable level (col 2. line 37-38). In addition to a head-

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adjusting element, Madsen also teaches a conveyor 11 for transporting the substrate from the fabrication and cleaning chamber to the material reclamation chamber.

- 10. In the cleaning chamber 12, a wash element 13 is included to apply a cleaning agent to the surface of the substrate for the removal of unconsolidated material. As stated previously, a water tank holds the wash water, which is the primary cleaning agent.
- 11. In regards to claim 40, 45-47 the chamber 12 comprises a cleaning zone, the tank 17 is a source for a cleaning agent, and wash element 13 contains nozzles for application of material located above the substrate. Furthermore, there is a plurality of said nozzles, and they emit a fluid that is, by nature, under pressure.
- 12. Claim 1, 40-44 are rejected under 35 U.S.C. 102(b) as being anticipated by Taniyama. Taniyama discloses a fabrication site with a cleaning component. The cleaning component includes a process unit 7a for cleaning, agent supplies 62, 64, 66, 68, and a nozzle 43 for application of cleaning agents. The nozzle is attached to a nozzle assembly 31, which is part of process fluid supply mechanism 30. The nozzle assembly is moved about a vertical shaft 50 by means of a drive mechanism 51. This allows the nozzle to move, and the drive mechanism controls the movement. Also included are flow rate control valves (col.8 line 3) to manipulate the flow of the agents thereby controlling operation of the applicator. Taniyama discloses that the nozzle can also be in a fixed location (col. 9 line 54)

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Claim Rejections - 35 USC § 103

- 13. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 14. Claim 9 10, 52-53, 55-56 are rejected under 35 U.S.C. 103(a) as being unpatentable over Sumnitsch in view of Madsen. As stated in paragraphs 4 and 7 above, Sumnitsch discloses all of the aspects of claim 1 through claim 8 and claim 49. However, he does not disclose the inclusion of a filter. Madsen, as stated in paragraph 8 above, does disclose the use of a filter in a substrate treating apparatus to separate the waste fluid into waste and a recyclable fluid. Furthermore, filters are commonly used throughout to perform material separation. It would have been obvious to one skilled in the art to modify Sumnitsch and include a filter to separate the waste fluid into its constituents.
- 15. Claim 48 is rejected under 35 U.S.C. 103(a) as being unpatentable over Madsen. Madsen discloses the limitations of claims 40, as presented above. He does not distinctly state that the cleaning zone is laterally adjacent to the fabrication site. However, he does state that conveyor 11 receives substrates that have been fabricated and are ready to be treated or cleaned (col 2 lines 9-19). Furthermore, Madsen's device depicts two laterally adjacent cleaning zones, one for application of material, and one for the removal of said material. It would have been obvious to one skilled in the

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art, to utilize the device disclosed by Madsen adjacent to the fabrication site with conveyor 11 connecting the two, as he implies.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Jason Heckert whose telephone number is (571) 272-2702. The examiner can normally be reached on Mon. to Friday, 8:00 - 5:00.

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Michael Barr can be reached on (571)272-1414. The fax phone number for the organization where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system. Status information for published applications may be obtained from either Private PAIR or Public PAIR. Status information for unpublished applications is available through Private PAIR only. For more information about the PAIR system, see http://pair-direct.uspto.gov. Should you have questions on access to the Private PAIR system, contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free). If you would like assistance from a USPTO Customer Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR CANADA) or 571-272-1000.

JMH

MICHAEL BARR SUPERVISORY PATENT EXAMINER